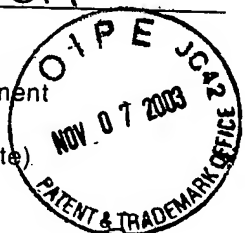


COOK, ALEX, McFARLAN,  
CUMMINGS & REARER

THE U.S. PATENT & TRADEMARK OFFICE  
OFFICIAL MAILROOM STAMP AFFIXED  
HERETO, ACKNOWLEDGES RECEIPT OF:

ENCLOSURES:

- ( ) Application \_\_\_\_\_
- ( ) Specification \_\_\_\_\_ pages
- ( ) Claims \_\_\_\_\_ pages
- ( ) Abstract \_\_\_\_\_ page(s)
- ( ) Drawing Sheets no. \_\_\_\_\_ (F) \_\_\_\_\_ (INF) \_\_\_\_\_
- ( ) Transmittal Letter
- (x) Check \$ 86.00 No: 15019
- ( ) Declaration/Oath
- ( ) Assignment and Cover Sheet
- ( ) Information Disclosure Statement
- ( ) Response/Amendment
- ( ) Extension of Time (In Duplicate)
- ( ) Small Entity Status
- ( ) Copy of Priority Document
- (x) Preliminary Amendment B



RE: APPLICATION ATTY/SEC: MJM/smw  
File no: 0553-0166.01  
Applicant: Yamazaki et al

S.N.: 10/629069 Filing Date: July 29, 2003  
Wiring material and a semiconductor device  
Title: HAVING A WIRING USING THE MATERIAL AND  
THE MANUFACTURING METHOD THEREOF

Due date: \_\_\_\_\_ Date Sent: 11/4/03

SEL  
0553-0166.01  
EDM/MJM

THE U.S. PATENT & TRADEMARK OFFICE  
OFFICIAL MAILROOM STAMP AFFIXED  
HERETO, ACKNOWLEDGES RECEIPT OF:

ENCLOSURES:

- ( ) Application \_\_\_\_\_  
( ) Specification \_\_\_\_\_ pages  
( ) Claims \_\_\_\_\_ pages  
( ) Abstract \_\_\_\_\_ page(s)  
( ) Drawing Sheets no. \_\_\_\_\_ (F) \_\_\_\_\_ (INF) \_\_\_\_\_  
( ) Transmittal Letter  
(x) Check \$ 86.00 No: 15019  
( ) Declaration/Oath  
( ) Assignment and Cover Sheet  
( ) Information Disclosure Statement  
( ) Response/Amendment  
( ) Extension of Time (In Duplicate)  
( ) Small Entity Status  
( ) Copy of Priority Document  
(x) Preliminary Amendment B

RE: APPLICATION

ATTY/SEC: MJM/smw

File no: 0553-0166.01

Applicant: Yamazaki et al

S.N.: 10/629069 Filing Date: July 29, 2003

Wiring Material And A Semiconductor Device

Title: Having A Wiring Using The Material And

The Manufacturing Method Thereof

Due date: \_\_\_\_\_ Date Sent: 11/4/03

**COOK ALEX MCFARRON MANZO  
CUMMINGS & MEHLER, LTD.**

200 W. ADAMS ST. • SUITE 2850  
CHICAGO, ILLINOIS 60606  
(312) 236-8500 • FED. ID NO. 36-4307193

LASALLE BANK, N.A.  
CHICAGO, ILLINOIS 60603

2-50/710

11/4/2003

PAY TO THE  
ORDER OF

Commissioner for Patents

\$ 86.00

Eighty-Six & No/100 Dollars

DOLLARS

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

MEMO

Stephen B. Helge  
Roy J. Miller

THIS DOCUMENT CONTAINS HEAT SENSITIVE INK. TOUCH OR PRESS HERE. RED IMAGE DISAPPEARS WITH HEAT.

COOK ALEX MCFARRON MANZO CUMMINGS & MEHLER, LTD.

11/4/2003 Commissioner for Patents  
Invoice Date Invoice No. Description  
11/4/2003 MJM-smw filing fee

Matter ID Amount  
0553-0166.01 86.00

SMW

15019



Attorney Docket 0553-0166.01

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of )  
)  
Yamazaki et al. )  
)  
Serial No.: 10/629,069 )  
)  
Filed: July 29, 2003 )  
)  
For: Wiring Material And A )  
Semiconductor Device Having A )  
Wiring Using the Material, And The )  
Manufacturing Method Thereof )  
)  
Art Unit: 2811 )  
)  
Examiner: )

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:  
Commissioner for Patents,  
P.O. Box 1450, Alexandria, VA 22313-1450 on

November 4, 2003

(Date of Deposit)

Shannon Wallace

Name of applicant, assignee, or Registered Rep.

Shannon Wallace 11/4/03

Signature

Date

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT B**

Sir:

Prior to examination and calculation of the fees, please amend the above-identified application as follows: